

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Product No: MTE5270P-C

### Peak Emission Wavelength: 527nm

The 527nm visible emitter series is designed for applications requiring high output and precise optical / mechanical axis alignment. Custom package solutions and sorting are available.

#### **FEATURES**

- > TO-18 Metal Can Domed Package
- > High Output Power
- > High Reliability
- > Narrow Beam Angle
- > Using Cree EZ950 Series Die

#### **APPLICATIONS**

- > Industrial Equipment
- > Medical
- > Machine Vision
- > Currency Validation
- > Light Source For Sensors



Absolute Maximum	Ratings	(Ta=25°C)		P	
ITEMS	SYMBOL	RATINGS	UNIT	lead-fr	RóHS
Forward Current (DC) *3	IF	150	mA		
Forward Current (Pulse) *1	IFP		Α		
Reverse Voltage	VR	5	V		
Power Dissipation	PD	480	mW		
Operating Temperature Range	Topr-	-40 ~ +100	°C		
Storage Temperature	Tstg	-40 ~ +120	°C		
Junction Temperature	Tj	150	°C		
Lead Soldering Temperature *2	Tls	260	°C		

<sup>\*1:</sup> Tw=10usec, T=10msec; \*2: Time 5 Sec max, Position: Up to 3mm from the body \*3: Proper heat sink required.

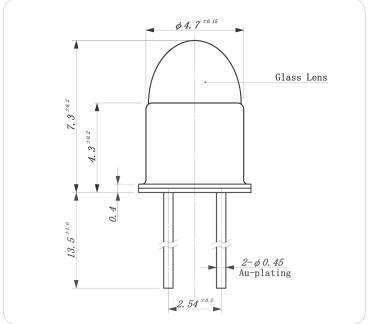
## Electrical & Optical Characteristics (Ta = 25°C)

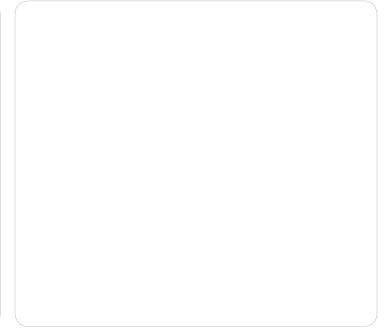
ITEMS	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT			
Power Output	PO	IF=50mA		23.9		mW			
Forward Voltage	VF	IF=50mA		2.7		V			
Reverse Current	IR	IF=50mA		2		μΑ			
Peak Emission Wavelength	λр	IF=50mA		527		nm			
Dominant Emission Wavelength	λd	IF=50mA		535		nm			
Spectral Line Half Width	Δλ	IF=50mA		35		nm			
Half Intensity Beam Angle	$\Theta$	IF=50mA		±6		deg			

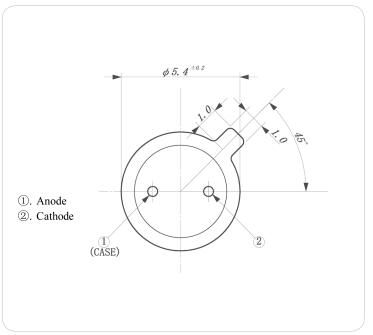
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## Package Dimensions





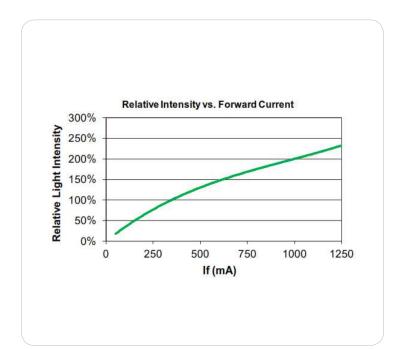


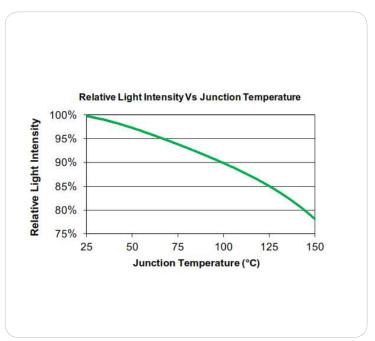


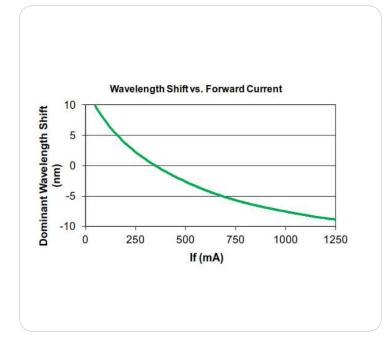
Unit: mm, Tolerance: ±0.2

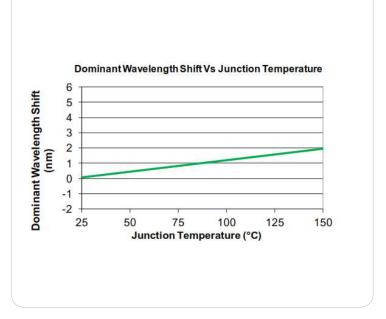


### Characteristic Curves (Ta = 25°C)



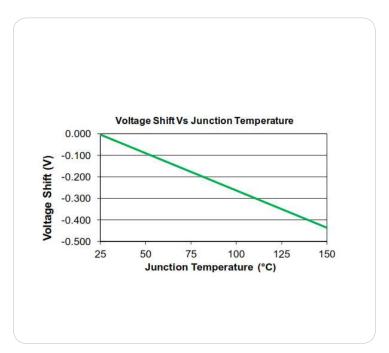


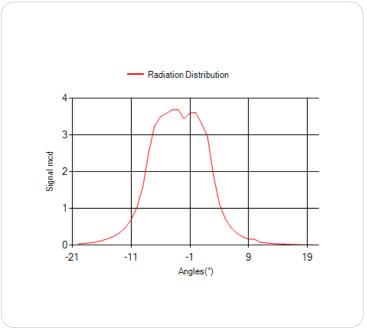


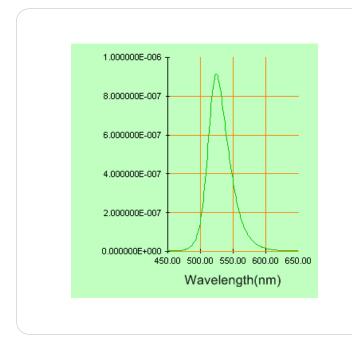


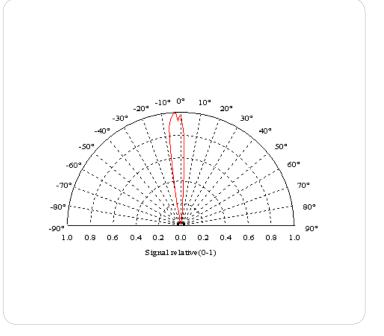


## Characteristic Curves (Ta = 25°C)









The information contained herein is subject to change without notice.

2016-09-01